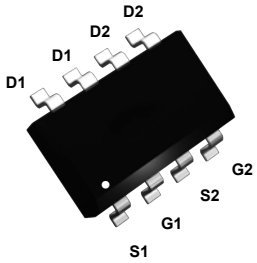
GOOD-ARK SEMICONDUCTOR

GSFQ2807

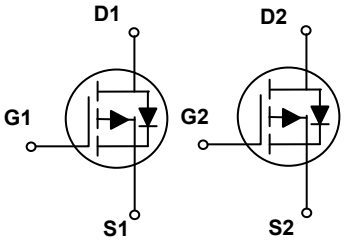
20V Dual P-Channel MOSFET

Main Product Characteristics

$V_{(BR)DSS}$	-20V
$R_{DS(ON)}$	21mΩ (Max.)
I_D	-12A



SOP-8



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery

Description

The GSFQ2807 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	±12	V
Drain Current-Continuous (T_A=25°C)	I_D	-12	A
Drain Current-Continuous (T_A=70°C)		-8.1	A
Drain Current-Pulsed[1]	I_{DM}	-48	A
Single Pulse Avalanche Energy[2]	E_{AS}	20	mJ
Single Pulse Avalanche Current[2]	I_{AS}	8.8	A
Power Dissipation (T_A=25°C)	P_D	1.7	W
Power Dissipation-Derate Above 25°C		0.013	W/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	79	°C/W
Storage Temperature Range	T_{STG}	-50 To +150	°C
Operating Junction Temperature Range	T_J	-50 To +150	°C

Electrical Characteristics (T_J=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On / Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=-250uA	-20	-	-	V
BV_{DSS} Temperature Coefficient	$\triangle BV_{DSS}/\triangle T_J$	Reference to 25℃, I_D=-1mA	-	-0.01	-	V/℃
Drain-Source Leakage Current	I_{DSS}	V_{DS}=-20V, V_{GS}=0V, T_J=25°C	-	-	-1	uA
		V_{DS}=-16V, V_{GS}=0V, T_J=125°C	-	-	-10	uA
Gate-Source Leakage Current	I_{GSS}	V_{GS}=±12V, V_{DS}=0V	-	-	±100	uA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-4.5V, I_D=-5A	-	15.6	21	mΩ
		V_{GS}=-2.5V, I_D=-4A	-	21	30	
		V_{GS}=-1.8V, I_D=-2A	-	33	51	
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}=V_{DS}, I_D=-250uA	-0.5	-0.75	-1.0	V
$V_{GS(th)}$ Temperature Coefficient	$\triangle V_{GS(th)}$		-	3	-	mV/℃
Forward Transconductance	gfs	V_{DS}=-5V, I_S=-5A	-	17	-	S
Dynamic and Switching Characteristics						
Total Gate Charge[2,3]	Q_g	V_{DS}=-10V, V_{GS}=-4.5V, I_D=-5A	-	15	-	nC
Gate-Source Charge[2,3]	Q_{gs}		-	2.6	-	
Gate-Drain Charge[2,3]	Q_{gd}		-	4.4	-	
Turn-On Delay Time[2,3]	$t_{d(on)}$	V_{DD}=-10V, V_{GS}=-4.5V, R_G=3Ω, I_D=-5A	-	9.1	-	nS
Rise Time[2,3]	t_r		-	28	-	
Turn-Off Delay Time[2,3]	$t_{d(off)}$		-	24	-	
Fall Time[2,3]	t_f		-	7.2	-	
Input Capacitance	C_{iss}	V_{DS}=-10V, V_{GS}=0V, F=1MHz	-	1984	-	pF
Output Capacitance	C_{oss}		-	241	-	
Reverse Transfer Capacitance	C_{rss}		-	227	-	
Source-Drain Ratings and Characteristics						
Continuous Source Current	I_S	V_G=V_D=0V, Force Current	-	-	-12	A
Pulsed Source Current	I_{SM}		-	-	-48	A
Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_S=-5A, T_J=25°C	-	-	-1.2	V

Notes:

1. Repetitive rating: pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width ≤300us, duty cycle ≤2%.
3. Essentially independent of operation temperature.

Typical Electrical and Thermal Characteristic Curves

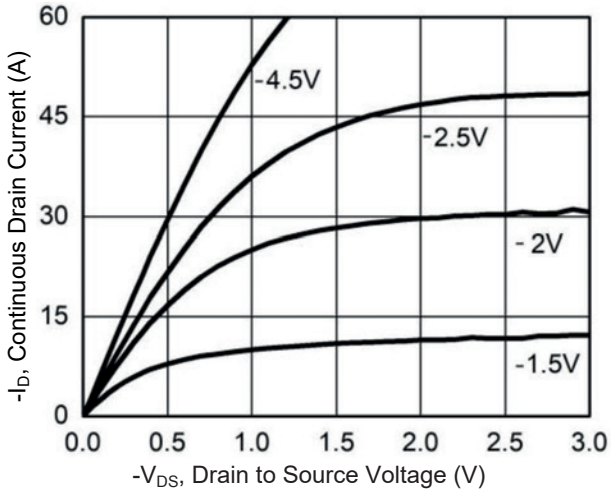


Figure 1. Output Characteristics

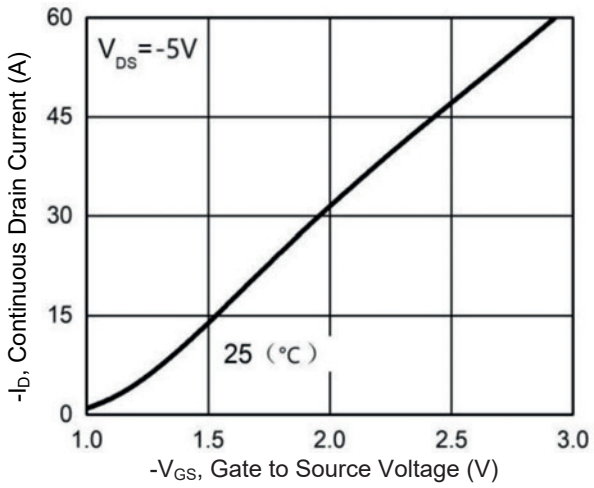


Figure 2. Transfer Characteristics

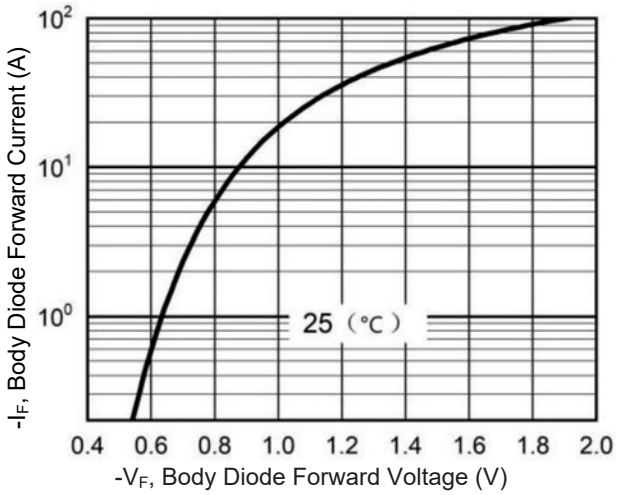


Figure 3. Body Diode Characteristics

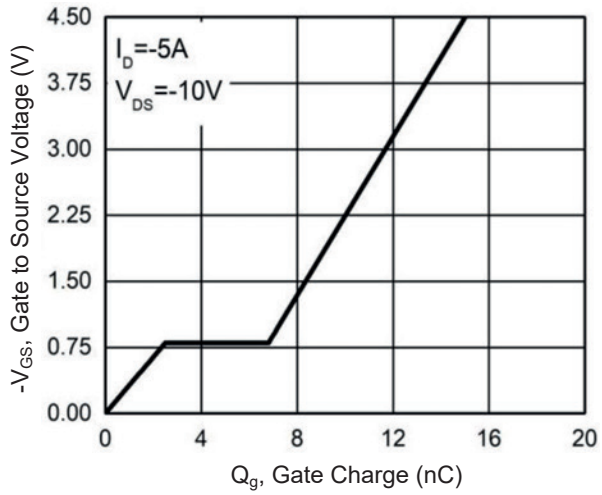


Figure 4. Gate Charge Waveform

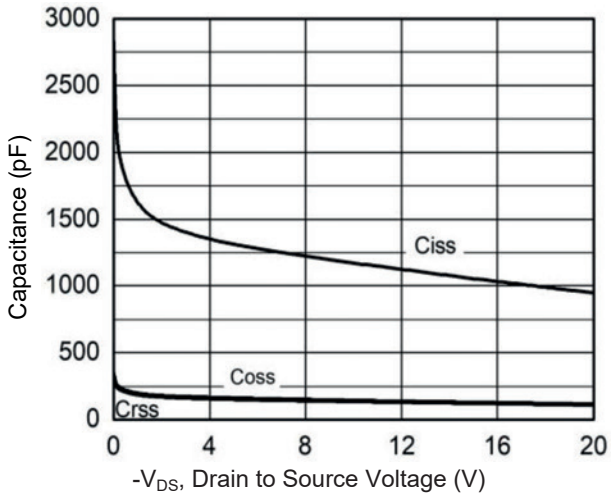


Figure 5. Capacitance Characteristics

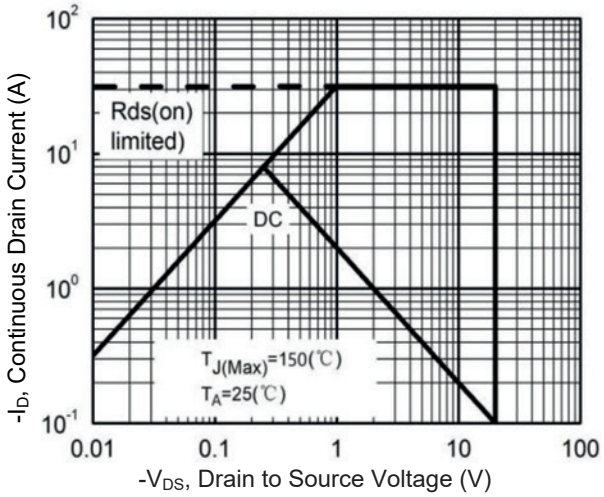
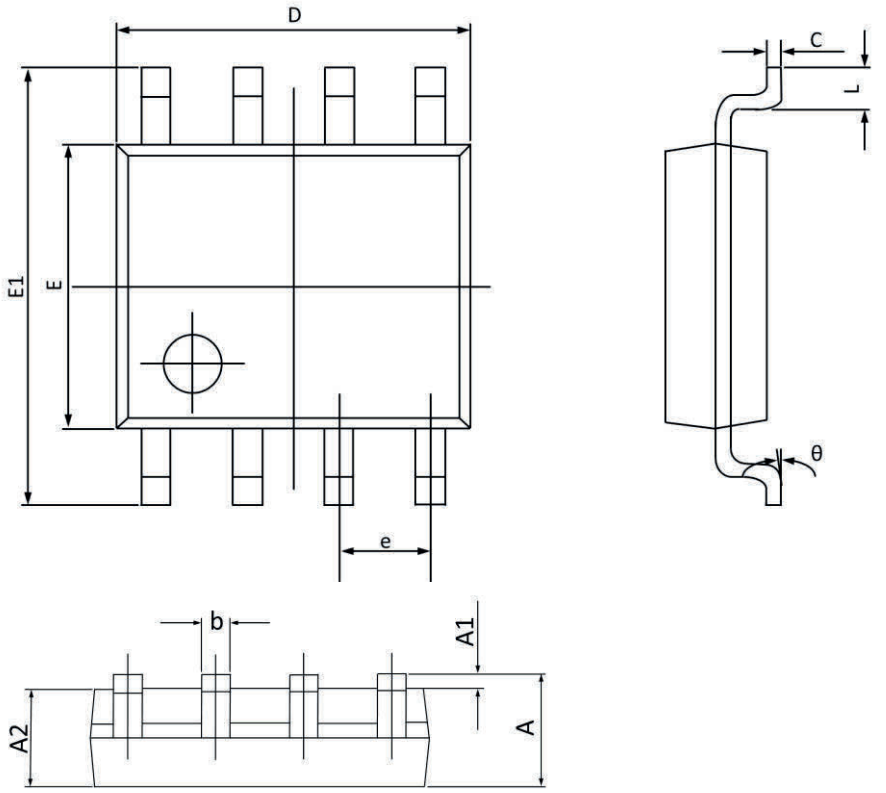


Figure 6. Maximum Safe Operation Area

Package Outline Dimensions (SOP-8)



Symbol	Dimensions In Inches		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.300	1.500	0.051	0.059
b	0.350	0.490	0.014	0.019
C	0.190	0.260	0.007	0.010
D	4.700	5.100	0.185	0.201
E	3.700	4.100	0.146	0.161
E1	5.800	6.200	0.228	0.244
e	1.27BSC		0.05BSC	
L	0.400	0.900	0.016	0.035
θ	0°	8°	0°	8°

Order Information

Device	Package	Marking	Carrier	Quantity
GSFQ2807	SOP-8	Q2807	Tape & Reel	3,000 Pcs / Reel